DEC 26 2006 0/634,274

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Paul A. Farrar

Examiner: Brook Kebede

Serial No.:

10/634,274

Group Art Unit: 2823

Filed:

August 5, 2003

Docket: 1303.110US1

Title:

H2 PLASMA TREATMENT

COMMUNICATION CONCERNING RELATED APPLICATION

MS RCE

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application in the above-identified patent application:

Serial/Patent No. Filing Date/Issue Date

Attorney Docket

Title

11458195

July 18, 2006

303.664US6

STRUCTURES AND METHODS TO **ENHANCE COPPER METALLIZATION**

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

PAUL A. FARRAR

By Applicant's Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

P.O. Box 2938

Minneapolis, MN 55402

(612) 371-2157

Reg. No. 46,632

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria,

VA 22313-1450, on this _____ day of <u>December</u>, 2006.